

Vishay Semiconductors

Small Signal Schottky Diodes

Features

- Integrated protection ring against static discharge
- · Low capacitance
- · Low leakage current
- · Low forward voltage drop
- · Very low switching time
- · AEC-Q101 qualified
- Compliant to RoHS directive 2002/95/EC and in accordance to WEEE 2002/96/EC





Applications

- HF-Detector
- · Protection circuit
- Diode for low currents with a low supply voltage
- · Small battery charger
- Power supplies
- DC/DC converter for notebooks

Mechanical Data

Case: MiniMELF SOD-80
Weight: approx. 31 mg
Cathode band color: black
Packaging codes/options:

GS18/10 k per 13" reel (8 mm tape), 10 k/box GS08/2.5 k per 7" reel (8 mm tape), 12.5 k/box

Parts Table

Part	Type differentiation	Ordering code	Remarks	
BAS81	V _R = 40 V	BAS81-GS18 or BAS81-GS08	Tape and Reel	
BAS82	V _R = 50 V	BAS82-GS18 or BAS82-GS08	Tape and Reel	
BAS83	V _R = 60 V	BAS83-GS18 or BAS83-GS08	Tape and Reel	

Absolute Maximum Ratings

T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Part	Symbol	Value	Unit
		BAS81	V _R	40	V
Reverse voltage		BAS82	V _R	50	V
		BAS83	V _R	60	V
Peak forward surge current	t _p = 1 s		I _{FSM}	500	mA
Repetitive peak forward current			I _{FRM}	150	mA
Forward continuous current			I _F	30	mA

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BAS81, BAS82, BAS83

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Thermal Characteristics

 T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit
Junction to ambient air	on PC board 50 mm x 50 mm x 1.6 mm	R_{thJA}	320	K/W
Junction temperature		T _j	125	°C
Storage temperature range		T _{stg}	- 65 to + 150	°C

Electrical Characteristics

T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Symbol	Min.	Тур.	Max.	Unit
Forward voltage	I _F = 0.1 mA	V _F			330	mV
	I _F = 1 mA	V _F			410	mV
	I _F = 15 mA	V _F			1000	mV
Reverse current	$V_R = V_{Rmax}$	I _R			200	nA
Diode capacitance	V _R = 1 V, f = 1 MHz	C _D			1.6	pF

Typical Characteristics

T_{amb} = 25 °C, unless otherwise specified

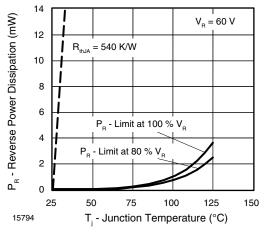


Figure 1. Max. Reverse Power Dissipation vs. Junction Temperature

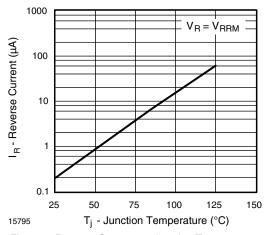


Figure 2. Reverse Current vs. Junction Temperature



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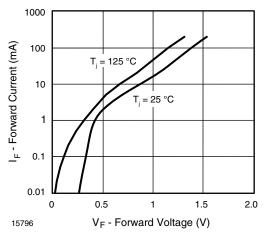


Figure 3. Forward Current vs. Forward Voltage

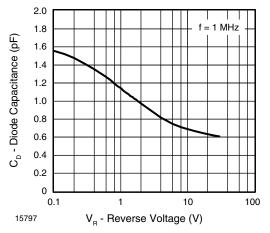
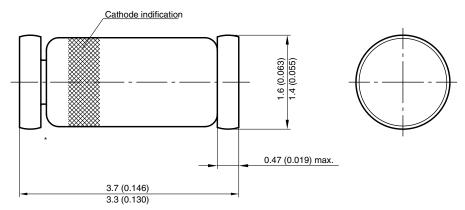


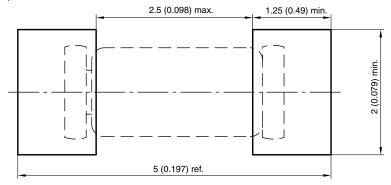
Figure 4. Diode Capacitance vs. Reverse Voltage

Package Dimensions in millimeters (inches): MiniMELF SOD-80



^{*} The gap between plug and glass can be either on cathode or anode side

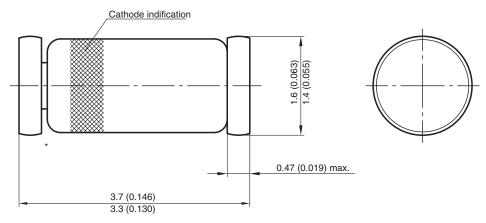




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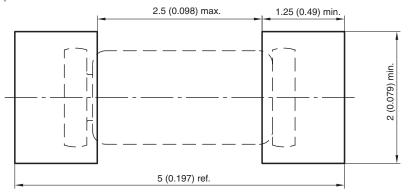
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PACKAGE DIMENSIONS in millimeters (inches)



* The gap between plug and glass can be either on cathode or anode side

Foot print recommendation:



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